

### 65V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C
	$22m\Omega$ @ $V_{GS} = 10V$	25.3A
65V	29mΩ @ V <sub>GS</sub> = 4.5V	22.1A

#### **Features and Benefits**

- 100% Unclamped Inductive Switching (UIS) Test in Production —
  Ensures More Reliable and Robust End Application
- Low R<sub>DS(ON)</sub> Ensures On-State Losses are Minimized
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

# **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(ON)})$ , yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Top View

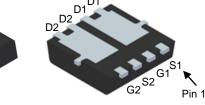
- · Wireless Charging
- DC-DC Converters
- Power Management

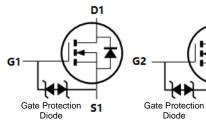
### **Mechanical Data**

- Case: PowerDI<sup>®</sup>3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

#### PowerDI3333-8 (Type UXC)







Internal Schematic

### Ordering Information (Note 4)

	_	
Part Number	Case	Packaging
DMT6017LDV-7	PowerDI3333-8 (Type UXC)	2,000/Tape & Reel
DMT6017LDV-13	PowerDI3333-8 (Type UXC)	3,000/Tape & Reel

**Bottom View** 

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



 $\frac{T7D}{YY} = \text{Product Type Marking Code}$   $\frac{T7D}{YY} = \text{Date Code Marking}$   $\frac{TY}{YY} = \text{Last Two Digits of Year (ex: 19 = 2019)}$  WW = Week Code (01 to 53)

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# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	65	V	
Gate-Source Voltage	$V_{GSS}$	±16	V	
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	$T_C = +25$ °C $T_C = +70$ °C	I <sub>D</sub>	25.3 20.3	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	100	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	25	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	100	Α
Avalanche Current, L = 0.1mH		I <sub>AS</sub>	19	Α
Avalanche Energy, L = 0.1mH		E <sub>AS</sub>	18	mJ

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5) $T_A = +25^{\circ}C$		$P_{D}$	0.98	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{ hetaJA}$	127.9	°C/W
Total Power Dissipation (Note 6)	$T_A = +25$ °C	P <sub>D</sub>	2.34	W
Thermal Resistance, Junction to Ambient (Note 6)		$R_{ heta JA}$	53.5	°C/W
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	5.9	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

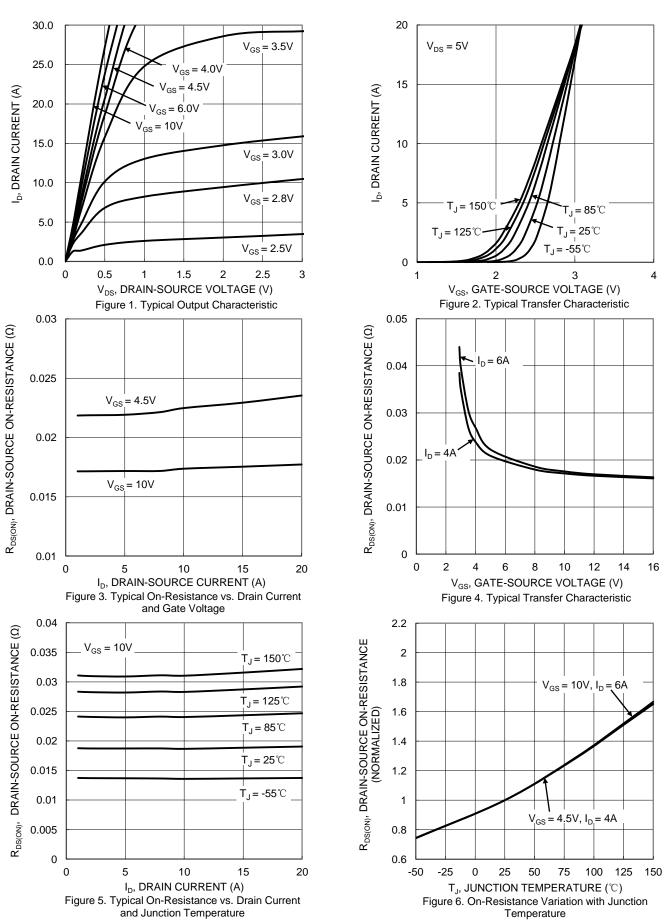
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

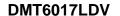
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)						•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	65	_	-	V	$V_{GS} = 0V$ , $I_D = 10mA$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 12.8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	$V_{GS(TH)}$	1	_	2.3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	2	_	17.5	22	mΩ	$V_{GS} = 10V, I_D = 6A$	
Static Dialii-Source Off-Resistance	R <sub>DS(ON)</sub>	_	22.3	29		$V_{GS} = 4.5V, I_D = 4A$	
Diode Forward Voltage	$V_{SD}$	_	0.7	1	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	891	-	pF	.,	
Output Capacitance	Coss	_	223		pF	$V_{DS} = 30V, V_{GS} = 0V,$ -f = 1MHz	
Reverse Transfer Capacitance	Crss	_	29	1	pF	T = TIVID2	
Gate Resistance	$R_g$	_	1.57	-	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	$Q_g$	_	7.5	1	nC		
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	_	15.3	1	nC	V 20V I CA	
Gate-Source Charge	$Q_{gs}$	_	1.8	1	nC	$V_{DS} = 30V, I_{D} = 6A$	
Gate-Drain Charge	Q <sub>qd</sub>	_	3.1	_	nC	1	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	4.0	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	5.9	_	ns	$V_{GS} = 10V, V_{DS} = 30V,$ $R_g = 3.3\Omega, I_D = 6A$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	11.7	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	3.3		ns		
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	21.1	_	ns		
Body Diode Reverse Recovery Charge	$Q_{RR}$	_	11.9	_	nC	$\frac{1}{1}$ IF = 6A, di/dt = 100A/ $\mu$ s	

5. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.

Bevice mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.









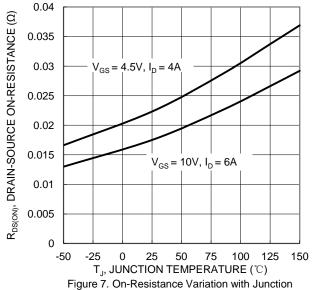


Figure 7. On-Resistance Variation with Junction Temperature

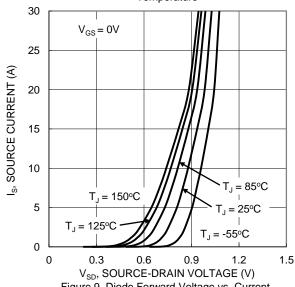


Figure 9. Diode Forward Voltage vs. Current 10 8 6  $V_{GS}(V)$ 4  $V_{DS} = 30V, I_{D} = 6A$ 2 0 2 8 10 12 14 16

 $Q_g$  (nC) Figure 11. Gate Charge

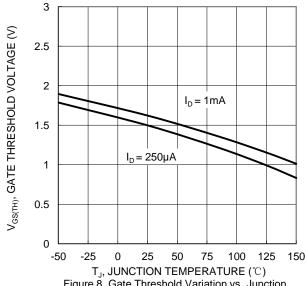
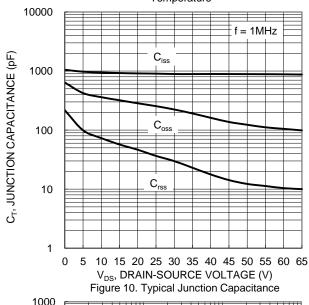
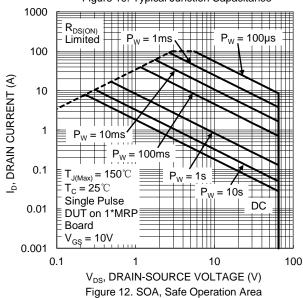


Figure 8. Gate Threshold Variation vs. Junction Temperature







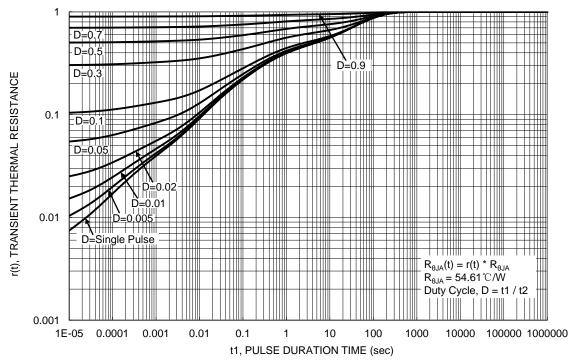


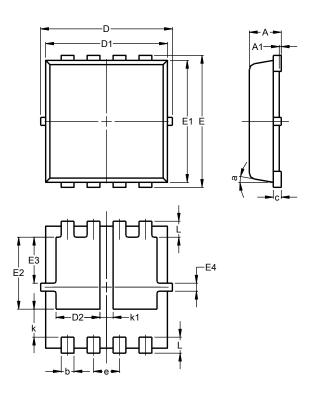
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## PowerDI3333-8 (Type UXC)

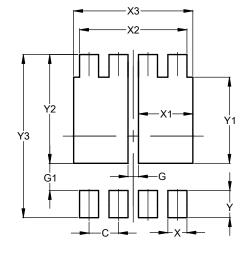


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PowerDI3333-8							
(Type UXC)							
Dim	Min	Max	Тур				
Α	0.75	0.85	0.80				
<b>A</b> 1	0.00	0.05					
b	0.25	0.40	0.32				
С	0.10	0.25	0.15				
D	3.20	3.40	3.30				
D1	2.95	3.15	3.05				
D2	0.90	1.30	1.10				
Е	3.20	3.40	3.30				
E1	2.95	3.15	3.05				
E2	1.60	2.00	1.80				
E3	0.95	1.35	1.15				
E4	0.10	0.30	0.20				
е	_	_	0.65				
L	0.30	0.50	0.40				
k	0.50	0.90	0.70				
k1	0.13	0.53	0.33				
а	0°	12°	10°				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8 (Type UXC)



Dimensions	Value (in mm)			
С	0.650			
G	0.230			
G1	0.600			
Х	0.420			
X1	1.200			
X2	2.370			
Х3	2.630			
Y	0.600			
Y1	1.900			
Y2	2.400			
Y3	3.600			



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